

Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

Claims 1-25 (cancelled)

Claim 26 (previously presented) A surface acoustic wave duplexer having an antenna terminal, a transmitting terminal and a receiving terminal, comprising:

 a transmitting SAW filter coupled between the antenna terminal and the transmitting terminal;

 a receiving SAW filter coupled between the antenna terminal and the receiving terminal;

 a common piezoelectric substrate on which both of the transmitting SAW filter and the receiving SAW filter are formed; and

 a package covering the common piezoelectric substrate, wherein the antenna terminal, the transmitting terminal and the receiving terminal are formed on the package;

 a frequency adjusting circuit being coupled between the antenna terminal and the transmitting SAW filter or the receiving SAW filter, wherein the frequency adjusting circuit has a capacitance element; and

 a branching filter circuit coupled between the frequency adjusting circuit and the transmitting SAW filter or the receiving SAW filter, wherein the branching filter circuit is formed on the package.

Claim 27 (previously presented) A surface acoustic wave duplexer according to claim 26, wherein the package has a first layer substrate and a second layer substrate, the first layer substrate is disposed on the second layer substrate, and the branching filter circuit is formed on the first layer substrate or the second layer substrate of the package.

Claim 28 (cancelled)

Claim 29 (previously presented) A surface acoustic wave duplexer according to claim 26, wherein the frequency adjusting circuit has an inductance element.

Claims 30-31 (cancelled)

Claim 32 (previously presented) A surface acoustic wave duplexer according to claim 26, wherein the frequency adjusting circuit is formed on the package.

Claims 33-38 (cancelled)

Claim 39 (previously presented) A surface acoustic wave duplexer having an antenna terminal, a transmitting terminal and a receiving terminal, comprising:

a SAW filter chip including a transmitting SAW filter connected with the transmitting terminal and a receiving SAW filter connected with the receiving terminal, wherein both the transmitting SAW filter and the receiving SAW filter are formed on one common piezoelectric substrate;

a package covering the one common piezoelectric substrate, wherein the antenna terminal, the transmitting terminal and the receiving terminal are formed on the package; and a frequency adjusting circuit being coupled between the antenna terminal and the transmitting SAW filter or the receiving SAW filter, wherein the frequency adjusting circuit has a capacitance element; and

a branching filter circuit being coupled between the frequency adjusting circuit and the transmitting SAW filter or the receiving SAW filter, wherein the branching filter circuit is formed on the package.

Claim 40 (previously presented) A surface acoustic wave duplexer according to claim 39, wherein the package has a first layer substrate and a second layer substrate, the first layer substrate being disposed on the second layer substrate, and the branching filter circuit is formed on the first layer substrate or the second layer substrate.

Claim 41 (cancelled)

Claim 42 (previously presented) A surface acoustic wave duplexer according to claim 39, wherein the frequency adjusting circuit has an inductance element.

Claims 43-46 (cancelled)

Claim 47 (currently amended) A surface acoustic wave duplexer according to claim 26, wherein the capacitance element is coupled in series between the antenna terminal and the transmitting SAW filter or the receiving SAW filter.

Claim 48 (previously presented) A surface acoustic wave duplexer according to claim 39, wherein the capacitance element is coupled in series between the antenna terminal and the transmitting SAW filter or the receiving SAW filter.

Claim 49 (currently amended) A surface acoustic wave duplexer according to claim 26, wherein the branching filter circuit comprises a serial [[alarm]]arm resonator.

Claim 50 (currently amended) A surface acoustic wave duplexer according to claim 39, wherein the branching filter circuit comprises a serial [[alarm]]arm resonator.

Claim 51 (new) A surface acoustic wave duplexer according to claim 26, wherein the package

has a multi-layer structure.

Claim 52 (new) A surface acoustic wave duplexer according to claim 39, wherein the package has a multi-layer structure.